501921234 05/15/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Isao NAGAOKI	04/24/2012
Toshiaki TANIGAKI	04/24/2012
Yoshihiro OHTSU	04/24/2012

RECEIVING PARTY DATA

Name:	Hitachi High-Technologies Corporation
Street Address:	24-14, Nishi Shimbashi 1-chome
City:	Minato-ku, Tokyo
State/Country:	JAPAN
Postal Code:	105-8717

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13505119

CORRESPONDENCE DATA

Fax Number: (202)628-8844 Phone: 202-624-2500

Email: tyhaynes@crowell.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Crowell & Moring LLP

Address Line 1: 1001 Pennsylvania Avenue, N.W.

Address Line 4: Washington, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	108147.64454US
NAME OF SUBMITTER:	Michael H. Jacobs

Total Attachments: 1

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PATENT

REEL: 028210 FRAME: 0938

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ASSIGNMENT

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI HIGH-TECHNOLOGIES CORPORATION, a corporation organized under the laws of Japan,

located at 24-14, Nishi Shimbashi 1-chome, Minato-ku, Tokyo 105-8717 Japan receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

TRANSMISSION ELECTRON MICROSCOPE AND SAMPLE OBSERVATION METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI HIGH-TECHNOLOGIES CORPORATION,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI HIGH-TECHNOLOGIES CORPORATION.

Signed on the date(s) indicated aside our signatures:

RECORDED: 05/15/2012

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Asao Naga olsi	4/24/2012
1) <u>Clsa O</u> Naga olsi Isao NAGAOKI 2) <u>Joshiaki Janigaki</u> Toshiaki TANIGAKI	4/24/2012
Toshiaki TANIGAKI 3) Yoshihiro Ohtsu Yoshihiro OHTSU	4/24/2012
Yoshihiro OHTSU 4)	
5)	
6)	
7)	
8)	
9)	
10)	

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